## **Towards Construction**





Barbara Jacak & Ernst Sichtermann UC Berkeley + LBNL Oct. 10, 2022



# A silicon tracker needs:

Barrel tracker & Endcap discs each need: sensors (vertex layers & sagitta layers may differ) mechanical design (vertex layers & sagitta layers will differ) cooling power interface cabling strategy electrical integration (Flex PCB, power gen config, etc. to end of staves/discs)

Overall mechanical support & integration of subsystems Services (cooling, power cables, RDO/config cables) barrel (vertex & tracker layers the same?); disks Readout electronics (no FEE as this is built into MAPS) Interlocks Slow controls & run control interface (usually these are a separate subsystem) Power distribution system DAQ interface

Each sub-system (vertex, sagitta/stave, disc) will have its own assembly structure

# We know

- Silicon barrel layout
   Should still investigate option of outer silicon layer
- Basic endcap disk positions
   Some optimization still underway
   Sensor tiling strategy being actively investigated
   ITS2 stave structure is a starting point
   Bakeout effects need investigation
   Commissioning plan is needed split assembly?
- Minimizing material is paramount!
   Must optimize mechanical supports & cones
   Need ultrathin supports for ultrathin sensors
   Air cooling highly desirable
   Does it need to be insulated from outside heat sources?
- Need hermetic acceptance Integration with beam pipe is complicated

## Interests expressed

- Sensor design RAL, BNL, LBNL
- Sensor assembly & testing
   INFN (Bari, Trieste, Padua), UK, LBNL, LANL, Wuhan, Korean groups?
- Mechanical support

#### **Vertex layers**

LBNL, INFN(Trieste, Bari, Padua), UK

#### Sagitta layers

ORNL, LBNL, UK

## Disks

LANL, LBNL, UK

## Cooling

LBNL, LANL, ORNL

### Data Cabling

BNL, ORNL

#### • Power distribution

UK, ORNL, LANL, BNL, JLab?

## Interests, continued

# Readout ORNL

- DAQ interface
   BNL, ORNL
- Slow controls
- Interlocks BNL
- Integration

JLab, BNL